

#### PACKAGE INFORMATION

#### **Mechanical Data**

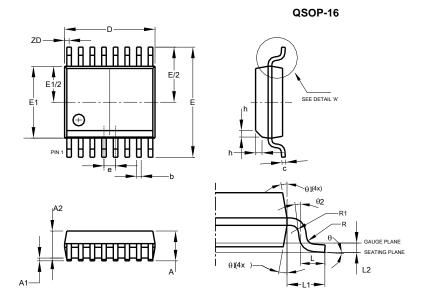
- Surface Mount Package
- Case Material: Molded Plastic, UL Flammability Rating 94V-0
- Terminals: Finish Matte Tin Plated Leads, Solderable per
- MIL-STD-202, Method 208 🐵
- Weight: 0.0813 grams (Approximate)
- Max Soldering Temperature 260°C for 30secs as per JEDEC J-STD-020

### **Package Outline Dimensions**

#### **Package View**

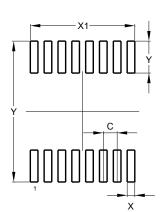


Top View



QSOP-16						
Dim	Min	Max	Тур			
Α	1.55	1.73	-			
A1	0.10	0.25	-			
A2	1.40	1.50	-			
b	0.20	0.30	-			
C	0.18	0.25	-			
D	4.80	5.00	-			
Е	5.79	6.20	-			
E1	3.81	3.99	-			
е	0.635 BSC					
h	0.254	0.508	-			
L	0.41	1.27	-			
L1	1.03 REF					
L2	0.254 BSC					
R	0.0762	-	-			
R1	0.0762	-	-			
ZD	0.23 REF					
θ	0°	8°	-			
θ1	5°	15°	-			
θ2	0°	-	-			
All Dimensions in mm						

### **Suggested Pad Layout**



QSOP-16

Dimensions	Value (in mm)	
С	0.635	
Х	0.350	
X1	4.795	
Y	1.450	
Y1	6.400	

Note: The suggested land pattern dimensions have been provided for reference only, as actual pad layouts may vary depending on application. These dimensions may be modified based on user equipment capability or fabrication criteria. A more robust pattern may be desired for wave soldering and is calculated by adding 0.2 mm to the 'Z' dimension. For further information, please reference document IPC-7351A, Naming Convention for Standard SMT Land Patterns, and for International grid details, please see document IEC, Publication 97.

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device Terminals and PCB tracking.



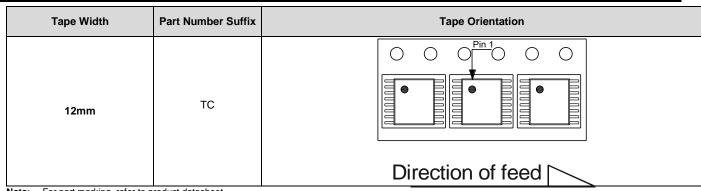
## **Minimum Packing Quantity**

		Quantity	Tape Width	Part Number Suffix		
	13" Reel	2,500	12mm	тс		
Note:	ote: Package quantities given are for minimum packaging quantity only, not minimum order quantity. For minimum order quantity, please con					
	Department.					

No mixed date codes or partial quantity (less than minimum packaging quantity) per packaging is allowed. Note<sup>.</sup>

In no case shall there be two or more consecutive components missing from any reel for any reason. Note:

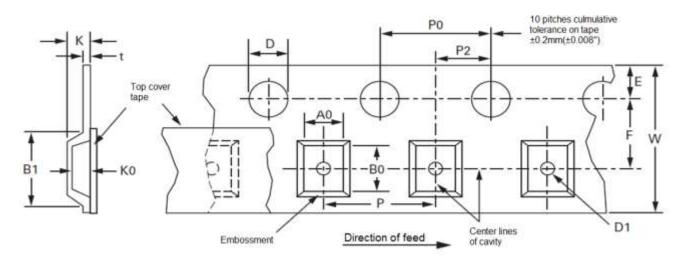
### **Device Tape Orientation**



Note:

For part marking, refer to product datasheet. Tape and package drawings are not to scale and are shown for device tape orientation only. Note:

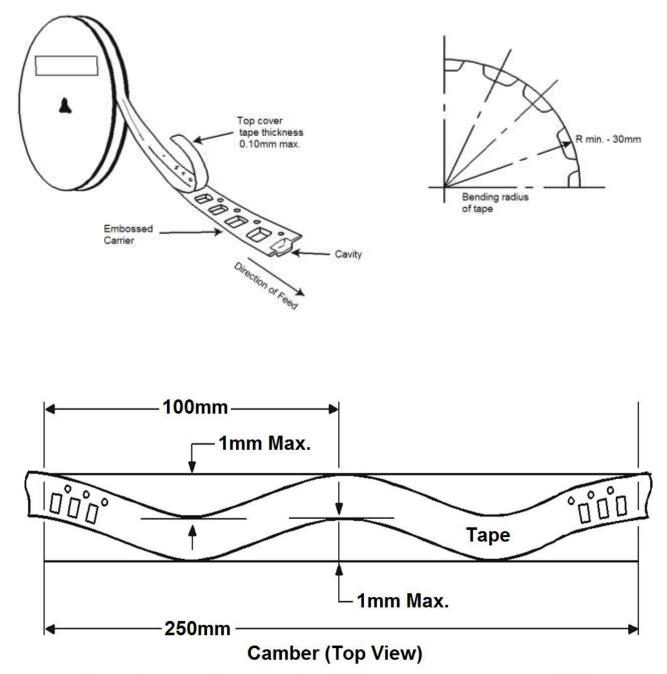
## **Embossed Carrier Tape Specifications**



Tape Width (W)	Dimension	Value (mm)	Dimension	Value (mm)	Dimension	Value (mm)	
	B1	8.2 max.	F	5.5±0.05	P2	2.0±0.05	
	D	1.5+0.10 -0.0	к	4.5 max.	t	0.40 max.	
12mm	D1	1.5 min.	P	8.0±0.10	w	12±0.30	
1211111	E	1.75±0.10	P0	4.0±0.10			
	A0 B0 K0	Determined by component size. The clearance between the component and the cavity must comply to the rotational and lateral movement requirement provided in figures in the "Maximum Component Movement in Tape Pocket" section.					



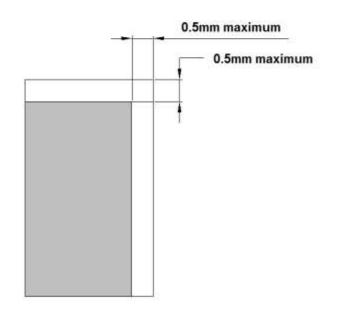
# **Embossed Carrier Tape Specifications**

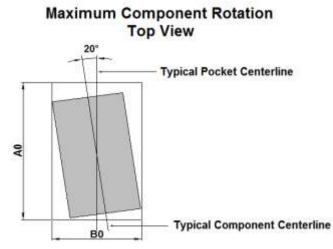


Allowable camber to be 1mm/100mm tape, non-cumulative

## Maximum Component Movement in Tape Pocket





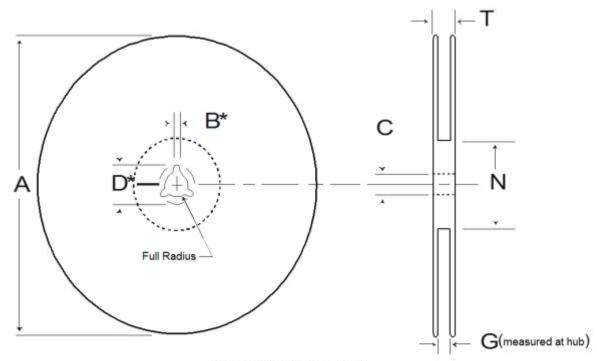


## Maximum Component Rotation Side View





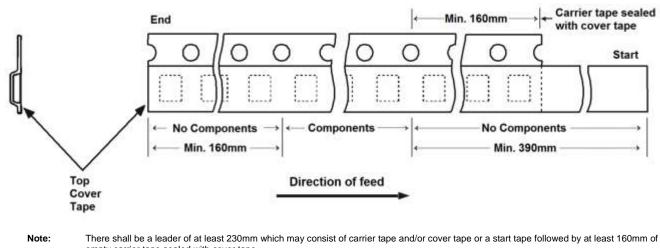
## **Surface Mount Reel Specifications**



<sup>\*</sup> Drive spokes optional. If used, dimensions with asterisks apply

Tape Width	Reel Size	A (mm)	B Max (mm)	C (mm)	D Max (mm)	N Min (mm)	G (mm)	T Max (mm)
12mm	13"	330 ±2	2.0 +0.5 -0	13 +0.5 -0.2	20.5 ±0.2	100 ±2	12.4 +2.0 -0.0	18.4

# **Tape Leader and Trailer Specifications**



empty carrier tape sealed with cover tape.
Note: There shall be a trailer of at least 160mm of empty carrier tape sealed with cover tape. The entire carrier tape must release from the reel

There shall be a trailer of at least 160mm of empty carrier tape sealed with cover tape. The entire carrier tape must release from the reel hub as the last portion of the tape unwinds from the reel without damage to the carrier tape and the remaining components in the cavities.